



CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

N-Channel Enhancement Mode Field Effect Transistor

VOLTAGE 200 Volts CURRENT 7.8 Ampere

CHM630PAPT

Lead free devices

APPLICATION

- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

FEATURE

- * Small package. (TO-252A)
- * Super high dense cell design for extremely low $R_{DS(ON)}$.
- * High power and current handling capability.

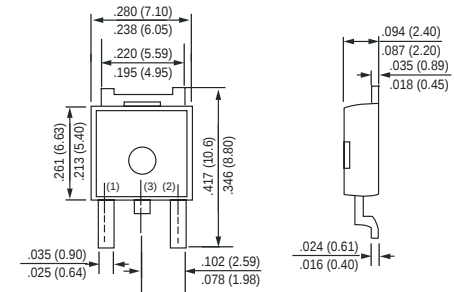
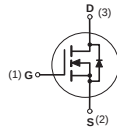
CONSTRUCTION

- * N-Channel Enhancement



TO-252A

CIRCUIT



- 1 Gate
2 Source
3 Drain(Heat Sink)

Dimensions in inches and (millimeters)

TO-252A

Absolute Maximum Ratings

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	CHM630PAPT	Units
V_{DS}	Drain-Source Voltage	200	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Maximum Drain Current - Continuous	7.8	A
	- Pulsed (Note 3)	31.2	
P_D	Maximum Power Dissipation at $T_c = 25^\circ\text{C}$	50	W
T_J	Operating Temperature Range	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$

- Note : 1. Surface Mounted on FR4 Board , $t \leq 10\text{sec}$
2. Pulse Test , Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
3. Repetitive Rating , Pulse width limited by maximum junction temperature
4. Guaranteed by design , not subject to production trsting

Thermal characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	50	$^\circ\text{C/W}$
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2006-02

RATING CHARACTERISTIC CURVES (CHM630PAPT)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	200			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 160\text{ V}, V_{GS} = 0\text{ V}$			25	μA
I_{GSSF}	Gate-Body Leakage	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$			+100	nA
I_{GSSR}	Gate-Body Leakage	$V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$			-100	nA

ON CHARACTERISTICS (Note 2)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2	3	4	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{ V}, I_D=5\text{ A}$			360	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=10\text{ V}, I_D = 5\text{ A}$	3	6		S

SWITCHING CHARACTERISTICS (Note 4)

Q_g	Total Gate Charge	$V_{DS}=160\text{ V}, I_D=5.9\text{ A}$ $V_{GS}=10\text{ V}$		27	32	nC
Q_{gs}	Gate-Source Charge			4		
Q_{gd}	Gate-Drain Charge			14.7		
t_{on}	Turn-On Time	$V_{DD}= 100\text{ V}$ $I_D=5\text{ A}, V_{GS}= 10\text{ V}$ $R_{GEN}= 50\text{ }\Omega$		50	60	nS
t_r	Rise Time			80	120	
t_{off}	Turn-Off Time			55	80	
t_f	Fall Time			40	50	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I_S	Drain-Source Diode Forward Current				7.8	A
V_{SD}	Drain-Source Diode Forward Voltage	$I_S = 7.8\text{ A}, V_{GS} = 0\text{ V}$			1.3	V